

### ☐ Mini-Circuits

#### 50Ω 800 to 6000 MHz 2-Way 90°

### **KEY FEATURES**

- High power handling, up to 70W
- Ultra wide bandwidth
- Good amplitude unbalance, ±0.4 dB

### **APPLICATIONS**

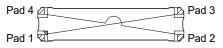
- Balanced amplifiers
- I&O modulators
- Defense and military



**OCH-63B+** 

Generic photo used for illustration purposes only

### **FUNCTIONAL DIAGRAM**



#### **PRODUCT OVERVIEW**

Mini-Circuits' QCH-63B+ is a 2-way 90° power splitter, capable of handling up to 70W with amplitude unbalance of ±0.4 dB typ and phase unbalance of ±5 deg. typ. Operating over a frequency range of 800 to 6000 MHz, the outstanding phase and amplitude unbalance make this component a versatile building block for use in a variety of systems and sub-system designs from balanced amplifiers and antenna feeds to military applications and more. The splitter is fabricated using laminated PCB process (1.80 x 0.40 x 0.19") and includes wrap-around terminations for good solderability and easy visual inspection.

### ELECTRICAL SPECIFICATIONS 1, 2 AT +25°C

Parameter	Conditions (MHz)	Min.	Тур.	Max.	Unit
Frequency Range	-	800	-	6000	MHz
Insertion Loss <sup>3</sup>	800 - 6000	-	0.5	1.1	dB
Isolation	800 - 6000	14.5	20	-	dB
Phase Unbalance	800 - 6000	-	±5.0	-	deg
Amplitude Unbalance	800 - 5800	-	±0.4	±0.85	dB
	5800 - 6000	-	±0.75	±1.3	
Return Loss	800 - 6000	12.5	20	-	dB
Thermal Resistance <sup>4</sup>	800 - 6000	-	1	-	°C/W

1. Tested in Evaluation Board TB-QCH-63B+. De-embbeded to the device reference plane.

2. Model is symmetrical and all ports are interchangeable, see Port Function Description/Configuration table for details and S-Parameters for actual performance.

3. Does not include theoretical loss due to coupling. Nominal theoretical loss is 3 dB.

4. Thermal Resistance is defined as  $\Theta$  ic= (Hot Spot Temperature on DUT - Base Plate Temperature)/Input Power.

### **ABSOLUTE MAXIMUM RATINGS 5**

Operating Case Temperature <sup>6</sup>		-55°C to +105°C	
Storage Temperature		-55°C to +105°C	
Power Input	+85°C case	70 W	
	+95°C case	60 W	
	+105°C case	50 W	

5. Permanent damage may occur if any of these limits are exceeded.

6. Case temperature is defined as temperature on base plate.

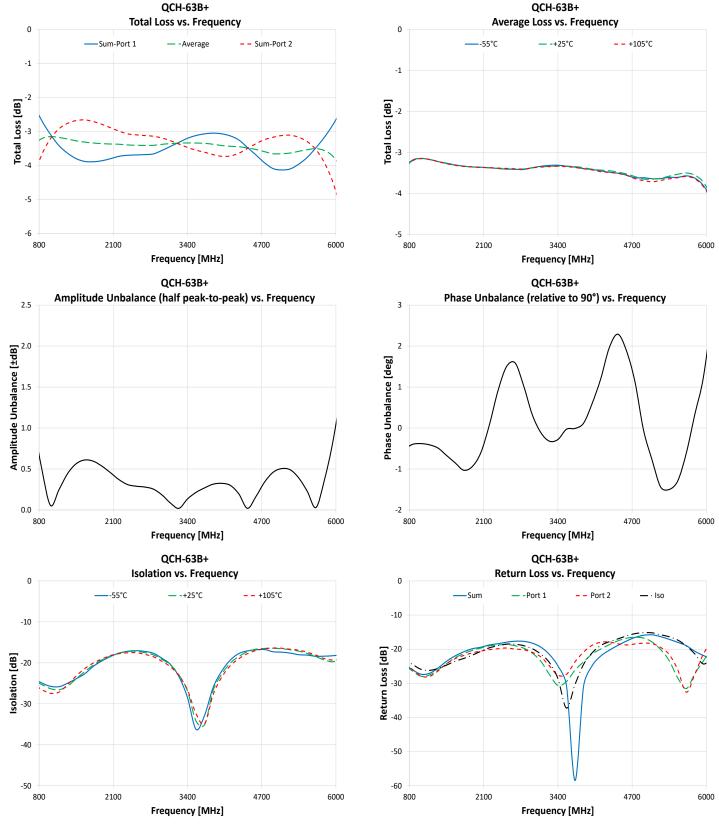
### **STRIPLINE SURFACE MOUNT** Power Splitter/Combiner 50Ω

## **QCH-63B+**

Mini-Circuits

800 to 6000 MHz 2-Way 90° 70W

### **TYPICAL PERFORMANCE GRAPHS\***



\* Data corresponds to Configuration A at +25°C unless otherwise specified.

### Mini-Circuits

### **STRIPLINE SURFACE MOUNT** ower Splitter/Combiner 50Ω

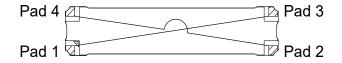
## **OCH-63B+**

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800 to 6000 MHz

2-Way 90° 70W

### **FUNCTIONAL DIAGRAM**



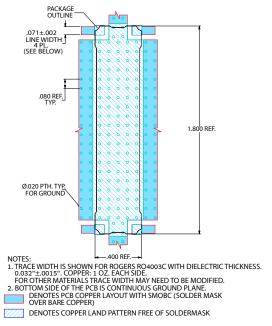
### PAD DESCRIPTION/CONFIGURATION 7

Function	Pad	Description
Sum	1	Sum port
Isolation	2	Isolation port
Port 1 (0°)	3	0° port
Port 2 (90°)	4	90° port
Ground	5	Ground

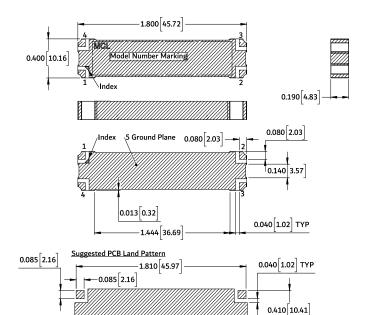
Configuration	Sum	Isolation	Port 1 (0°)	Port 2 (90°)
A	1	2	3	4
В	2	1	4	3
С	3	4	1	2
D	4	3	2	1

7. Model is symmetrical and all ports are interchangeable, see Port Function Configurations table and s-parameters for actual performance.





### **CASE STYLE DRAWING** (PQ2181)



NOTES:

3.

Base material: Printed wiring laminate. 1. 2.

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Metallization

Termination finish: 2-5 µinch (.05-.13 microns) Immersion Gold. Dimensions: Inches [mm]. Tolerances 2 Pl. ±.03 inch; 3 Pl. ±.010 inch.

1.560 39.62

Weight: 1.0 grams

Solder Resist

0.015 0.38

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- 4. 5. Marking may contain other features or characters for internal lot control.

### PRODUCT MARKING\*: QCH-63B+

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### Mini-Circuits

# STRIPLINE SURFACE MOUNT Power Splitter/Combiner

Mini-Circuits

**RoHS Status** 

Tape and Reel

**Evaluation Board** 

**Environmental Rating** 

Suggested Layout for PCB Design

50Ω 800 to 6000 MHz 2-Way 90° 70W

Compliant

F120

PL-539

TB-QCH-63B+

Gerber file

# ADDITIONAL DETAILED INFORMATION IS AVAILABLE ON OUR DASH BOARD CLICK HERE Performance Data & Graphs Data Graphs Graphs S-Parameter (S4P files) data set (.zip file) de-embedded to device pads PQ2181 Lead finish: 2-5 µ inch (0.05-0.13 microns) immersion gold

NO	Т	ES:

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.

B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.

C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at <a href="https://www.minicircuits.com/terms/viewtem.html">https://www.minicircuits.com/terms/viewtem.html</a>

